Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	B170/B	B180/B	B190/B	B1100/B	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	70	80	90	100	V
RMS Reverse Voltage	$V_{R(RMS)}$	49	56	63	70	V
Average Rectified Output Current @ T_T = +125°C	I_O	1.0				A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I_{FSM}	30				A
Repetitive Peak Reverse Current	I_{RRM}	1.0				A

Thermal Characteristics

Characteristic	Symbol	B170/B	B180/B	B190/B	B1100/B	Unit
Typical Thermal Resistance Junction to Terminal (Note 5)	$R_{\theta JT}$	25				°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +150				°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V_F	—	—	0.79 0.69	V	I_F = 1.0A, T_A = +25°C I_F = 1.0A, T_A = +100°C
Leakage Current (Note 6)	I_R	—	—	0.5 5.0	mA	@ Rated V_R, T_A = +25°C @ Rated V_R, T_A = +100°C
Total Capacitance	C_T	—	—	80	pF	V_R = 4V, f = 1MHz

Notes: 5. Valid provided that terminals are kept at ambient temperature.
6. Short duration pulse test used to minimize self-heating effect.

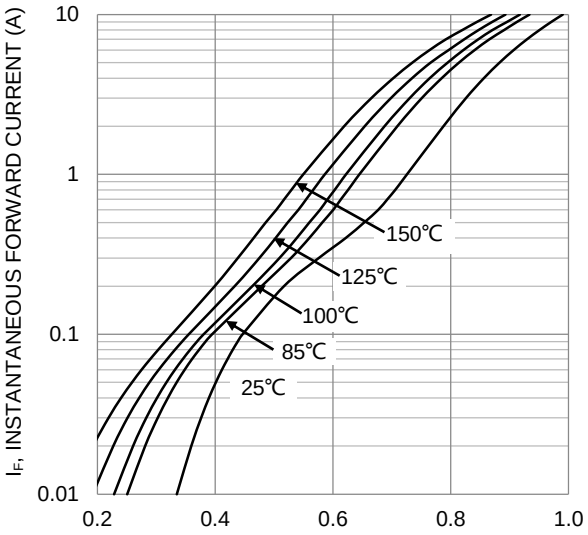


Fig.1 Typical Forward Characteristics

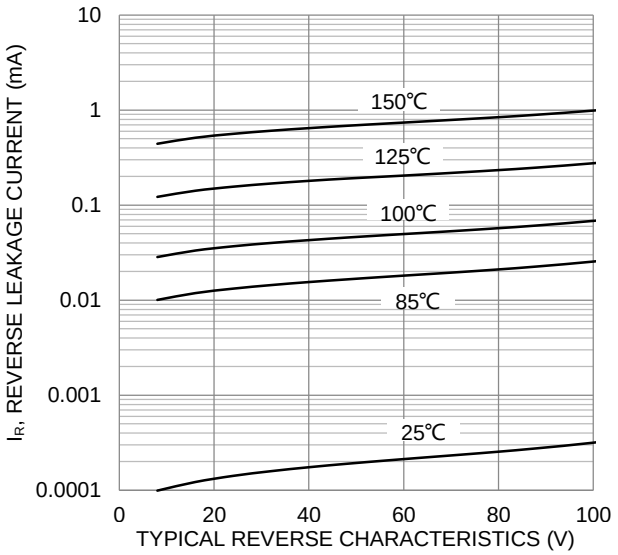


Fig. 2 Reverse Leakage Current vs. Typical Reverse Characteristics

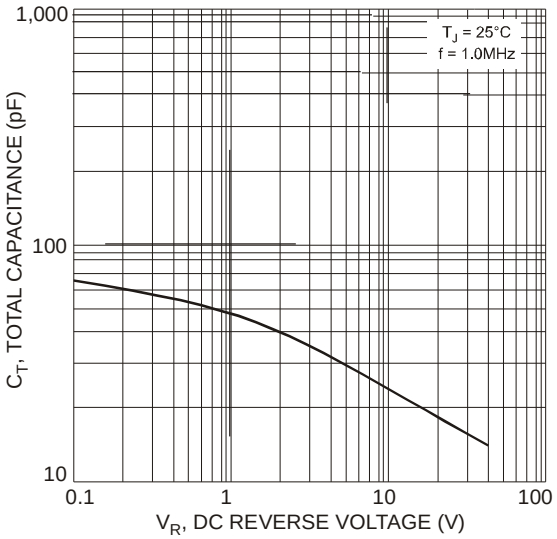


Fig.3 Total Capacitance vs. Reverse Voltage

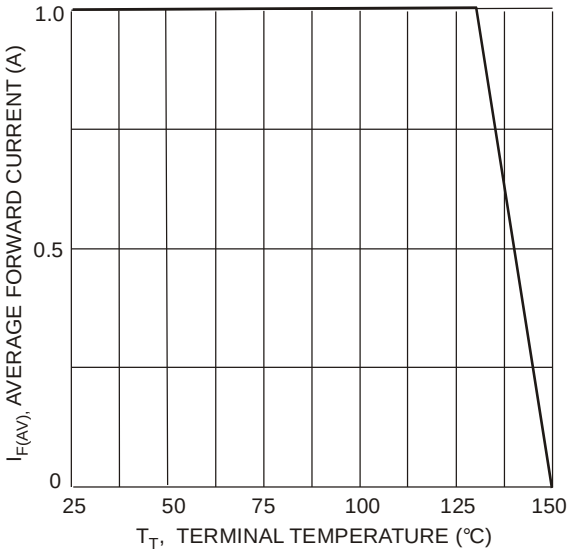


Fig.4 Forward Current Derating Curve

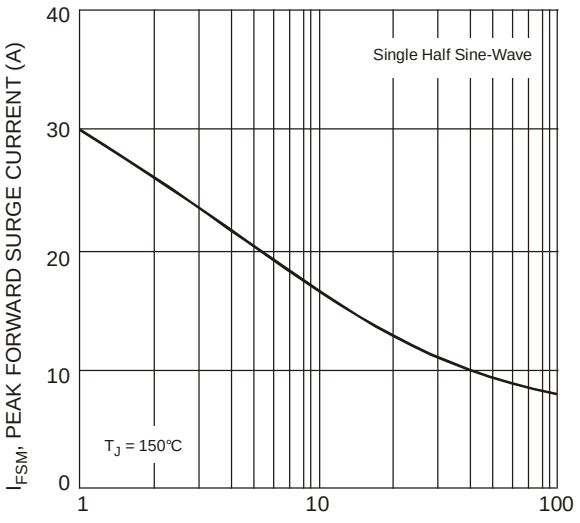
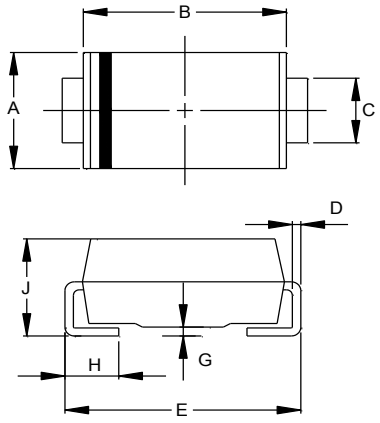


Fig.5 Max Non-Repetitive Peak Forward Surge Current

Package Outline Dimensions

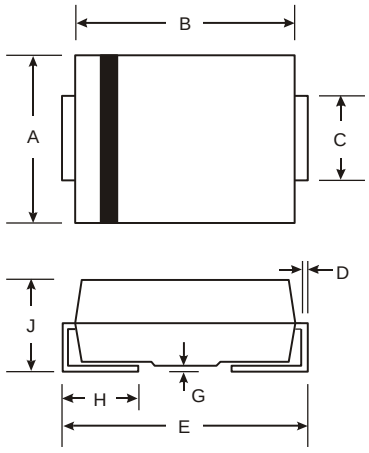
Please see http://www.diodes.com/package-outlines.html for the latest version.

SMA



SMA		
Dim	**Min**	**Max**
A	2.29	2.92
B	4.00	4.60
C	1.27	1.63
D	0.15	0.31
E	4.80	5.59
G	0.05	0.20
H	0.76	1.52
J	1.96	2.40
All Dimensions in mm		

SMB

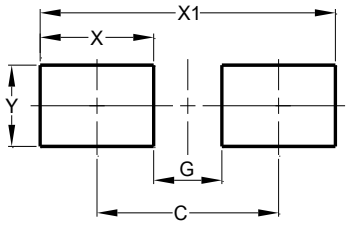


SMB		
Dim	**Min**	**Max**
A	3.30	3.94
B	4.06	4.57
C	1.96	2.21
D	0.15	0.31
E	5.00	5.59
G	0.05	0.20
H	0.76	1.52
J	2.00	2.50
All Dimensions in mm		

Suggested Pad Layout

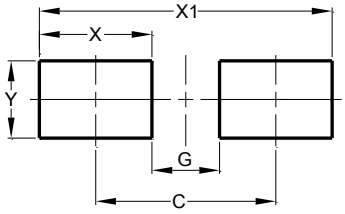
Please see http://www.diodes.com/package-outlines.html for the latest version.

SMA



Dimensions	Value (in mm)
C	4.00
G	1.50
X	2.50
X1	6.50
Y	1.70

SMB



Dimensions	Value (in mm)
C	4.30
G	1.80
X	2.50
X1	6.80
Y	2.30

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